

APPLICABLE STANDARD				
RATING	OPERATING TEMPERATURE RANGE	-35°C TO +85°C (NOTES 1)	STORAGE TEMPERATURE RANGE	-10°C TO +60°C (NOTE3)
	OPERATING HUMIDITY RANGE	20 % TO 80 % (NOTES 2)	STORAGE HUMIDITY RANGE	40 % TO 70 % (NOTE3)
	VOLTAGE	150 V AC (DC)	CURRENT	1 A
	APPLICABLE CONNECTOR	DF13-*S-1.25C	APPLICABLE CONTACT	DF13(G)-2630SCFA DF13-3032SCFA

SPECIFICATIONS

ITEM	TEST METHOD	REQUIREMENTS	QT	AT
CONSTRUCTION				
GENERAL EXAMINATION	VISUALLY AND BY MEASURING INSTRUMENT.	ACCORDING TO DRAWING.	X	X
MARKING	CONFIRMED VISUALLY.		X	X
ELECTRIC CHARACTERISTICS				
CONTACT RESISTANCE	100 m A (DC OR 1000 Hz).	30 mΩ MAX.	X	-
INSULATION RESISTANCE	100 V DC.	500 MΩ MIN.	X	-
VOLTAGE PROOF	500 V AC FOR 1 min.	NO FLASHOVER OR BREAKDOWN.	X	-
MECHANICAL CHARACTERISTICS				
MECHANICAL OPERATION	50 TIMES INSERTIONS AND EXTRACTIONS.	① CONTACT RESISTANCE: 30 mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	-
VIBRATION	FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	-
SHOCK	490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.		X	-
ENVIRONMENTAL CHARACTERISTICS				
RAPID CHANGE OF TEMPERATURE	TEMPERATURE -55→ 15 TO 35→+85→ 15 TO 35 °C TIME 30→ 2 TO 3→30→ 2 TO 3 min. UNDER 5 CYCLES.	① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 500 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	-
DAMP HEAT (STEADY STATE)	EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.		X	-
RESISTANCE TO SOLDERING HEAT	1) REFLOW SOLDERING «REFLOW AREA» 250°C MAX 10 sec MAX 230°C MIN 60 sec MAX «PREHEATING AREA» 170°C TO 190°C 60 sec TO 120 sec PUT THROUGH IN REFLOW FURNACE TWICE, LEAVE IN AMBIENT TEMPERATURE AND HUMIDITY FOR 1 HOUR. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE :350°C, SOLDERING TIME : 3sec. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	-
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 245°C FOR INSERTION DURATION, 3sec.	SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSSED.	X	-

REMARKS

NOTE1: INCLUDE THE TEMPERATURE RISING BY CURRENT

NOTE2:NO CONDENSING

NOTE3:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD,

AFTER PCB BOARD , OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE DURING TRANSPORTATION.

Unless otherwise specified, refer to JIS C 5402.

COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
△				
		APPROVED	TS. SAKATA	09. 11. 04
		CHECKED	TS. FUKUSHIMA	09. 11. 04
		DESIGNED	KT. ISHII	09. 11. 01
		DRAWN	KT. ISHII	09. 11. 01
Note QT:Qualification Test AT:Assurance Test X:Applicable Test		DRAWING NO.		ELC4-162444-07
HRS	SPECIFICATION SHEET	PART NO.	DF13A-*P-1. 25H (51)	
	HIROSE ELECTRIC CO., LTD.	CODE NO.	CL536	△ 1/1